

SP8127

High Speed Differential APC Amplifier

FEATURES

- Dual wavelength 650 and 780nm
- 100 MHz Bandwidth
- 300 V/µs Slew Rate
- 5 ns Setting Time
- 10 mV Differential Output Offset Voltage
- 25 mV/°C Output Offset Voltage Drift
- -6/+6 dB External Gain Adjust
- Small 8-pin OPLGA package



APPLICATION

- CD-R, and CD-RW
- DVD+/-R, DVD+/-RW, and DVD-RAM

GENERAL DESCRIPTION

The SP8127 is a high-speed, differential output APC amplifier that integrates the photodiode and adjustable gain block on one chip. Independent gain control allows individual adjustment for 780mn and 650nm wavelength operation, as found in CD/DVD optical storage drives. This allows the user to control the laser power of the system in high-speed DVD+/-RW, DVD-RAM and CD-RW systems. The wide 2V output swing also allows better system performance, through improved dynamic range.



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ABSOLUTE MAXIMUM RATINGS

These are stress ratings only and functional operation of the device at these ratings or any other above those indicated in the operation sections of the specifications below is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

| Supply Voltage (Vcc) | 6.0V |
|---------------------------|-------------|
| Reference Voltage (Vs) | 6.0V |
| Output Voltage (Vout) | Vcc |
| Junction Temperature (Tj) | 120 °C |
| Storage Temperature40° | C to +100°C |
| Soldering Temperature | +235°C |

RECOMMENDED OPERATING CONDITIONS

| Supply Voltage (Vcc) | 4.5V to 5.5V |
|-----------------------|--------------|
| Operating temperature | 20C to +85°C |
| CD Wavelength | 780nm |
| DVD Wavelength | |

THERMAL SPECIFICATIONS

8-pin OPLGA (3 x 3.5mm) Package Thermal Resistance........... 75 °C/W



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ELECTRICAL/OPTICAL SPECIFICATIONS

Unless otherwise noted: Vcc = 5V, output load: R_L = 1kΩ, C_L = 20pF, gain 0 dB, ambient temperature -20C ≤Ta ≤ +85 °C

| Parameter | Condition | Min. | Тур. | Max | Unit | |
|--|--|---------|-------|---------|-----------------|--|
| | Ta = 25 °C, no signal, no load | | 15 | | | |
| Supply Current | -20 ≤Ta ≤ +85 °C, no signal, no load | | | 20 | mA | |
| Output Common Mode Voltage | No signal | Vcc/2.2 | Vcc/2 | Vcc/1.8 | V | |
| Output Offact Voltage | Gain = 0dB, no signal | -10 | | 10 | mV | |
| Output Offset Voltage | Gain = +6dB, no signal | -20 | | 20 | | |
| Output Offset Voltage Drift | Gain = 0dB, no signal | -25 | | 25 | μV/°C | |
| | Gain = + 6dB, no signal | -50 | | 50 | | |
| Power Supply Rejection Ratio (PSRR) * | Gain = 0dB, 4.5V ≤ Vcc ≤ 5.5V | 55 | 76 | | dB | |
| Output Sensitivity | Gain = 0dB | 4560 | 5700 | 6840 | V/W | |
| Input Optical Power required to produce a 2V differential output swing | 0.28mm laser beam diameter, uniform density, Gain = 0dB | | 263 | | μW | |
| Photo Detector Active Area | | | 0.098 | | mm ² | |
| Output Settling Time | Gain = -6dB, 2Vpp step | | 5 | 7 | ns | |
| | Gain = 0dB, 2Vpp step | | 6 | 9 | | |
| Full Scale Output Voltage Swing | Differential voltage = (V+) – (V-) | 2 | | | V p-p | |
| Description delth | Gain = -6dB, -3dB level | 80 | 100 | | MHz | |
| Bandwidth | Gain = 0dB, -3dB level | 60 | 80 | | | |
| Gain Adjust Range | | -6 | | +6 | dB | |

PIN ASSIGNMENTS

| Pin # | Pin Name | Pin Function |
|-------|----------|--|
| 1 | Vcc | Supply Voltage. Bypass to GND with ceramic capacitor 0.1µF |
| 2 | Gain | Gain Switch Input. Low level selects Rg1, high level selects Rg2 |
| 3 | Rc | Common connection point for Rg1 and Rg2 |
| 4 | GND | Power Ground |
| 5 | Rg1 | Gain Adjust 1 |
| 6 | Rg2 | Gain Adjust 2 |
| 7 | Vout (–) | Output Voltage Negative Swing |
| 8 | Vout(+) | Output Voltage Positive Swing |

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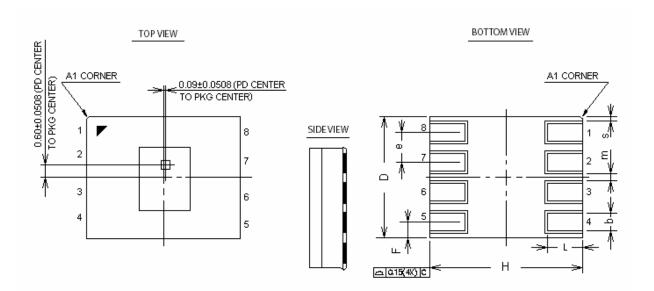
SIPEX RESERVES THE RIGHT TO MAKE CHANGES TO THIS DATASHEET. CALL FOR UPDATES: 1-978-667-8700.

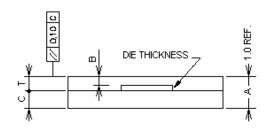
^{*)} PSRR = 20log (ΔVcc/ΔVout)
**) Gain Linearity = (Gain2 – Gain 1)/Gain 1, where Gain = Vout/Pin. This test is done with current injection at the wafer level.



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OPLGA 8-pin PACKAGE DIMENSIONS





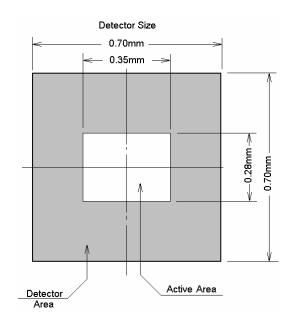
NOTE: DIE THICKNESS 0.2mm (8MIL)

| COMMISSION C | DIMENSIONS IN MILLIMETERS | | |
|--------------|---------------------------|------|------|
| SYMBOLS | MIN | NOM | MAX |
| Α | 0.90 | 1.00 | 1.10 |
| b | 0.30 | 0.40 | 0.50 |
| С | - | 0.56 | ı |
| D | 2.90 | 3.00 | 3.10 |
| В | 0.19 | | 0.32 |
| Н | 3.40 | 3.50 | 3.60 |
| е | ı | 0.75 | I |
| F | 0.28 | 0.38 | 0.48 |
| L | 0.50 | 0.60 | 0.70 |
| T | ı | 0.45 | l |
| S | 0.075 | - | - |
| m | 0.10 | _ | _ |



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PHOTO DETECTOR PATTERN



ORDERING INFORMATION

| Part number | Temperature range | Package Type |
|-------------|--------------------------|--------------|
| SP8127DG | -20C + 85 ⁰ C | 8-pin OPLGA |